



Sim. to ISO 62

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ISO 1183

### HOSTAFORM® SlideX® C0304 XAP®2 **HOSTAFORM®**

POM copolymer Injection molding grade with tribological modification for demanding applications that require prevention of audible noise caused by stick-slip phenomenon. Excellent tribological performance with low friction and low wear under various conditions of sliding against plastics and metals. Reduced emission grade. Emissions according to VDA 275 < 5 mg/kg.

Chemical abbreviation according to ISO 1043-1: POM Molding compound ISO 29988-1: POM-K | M-GNRS2 | 5-2 | - | POM copolymer

Product information Resin Identification	POM		ISO 1043
Part Marking Code	>POM<		ISO 1043
	, , ,		
Rheological properties			
Melt volume-flow rate		cm <sup>3</sup> /10min	ISO 1133
Temperature	190	_	
Load	2.16	-	100 004 4 0577
Moulding shrinkage, parallel	1.9		ISO 294-4, 2577
Moulding shrinkage, normal	1.8	%	ISO 294-4, 2577
Typical mechanical properties			
Tensile modulus	2500	MPa	ISO 527-1/-2
Tensile stress at yield, 50mm/min	56	MPa	ISO 527-1/-2
Tensile strain at yield, 50mm/min	8	%	ISO 527-1/-2
Nominal strain at break	45	%	ISO 527-1/-2
Flexural modulus	2350		ISO 178
Flexural strength		MPa	ISO 178
Charpy impact strength, 23°C		kJ/m²	ISO 179/1eU
Charpy impact strength, -30°C		kJ/m²	ISO 179/1eU
Charpy notched impact strength, 23°C		kJ/m <sup>2</sup>	ISO 179/1eA
Charpy notched impact strength, -30°C		kJ/m²	ISO 179/1eA
Ball indentation hardness, H 358/30 Poisson's ratio	0.38 <sup>[C]</sup>	MPa	ISO 2039-1
[C]: Calculated	0.36		
[O]. Galculated			
Thermal properties			
Melting temperature, 10°C/min	166	°C	ISO 11357-1/-3
Temperature of deflection under load, 1.8 MPa	90	°C	ISO 75-1/-2
Coefficient of linear thermal expansion (CLTE), parallel	140	E-6/K	ISO 11359-1/-2
Coefficient of linear thermal expansion (CLTE), normal	140	E-6/K	ISO 11359-1/-2

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0.2 %

1400 kg/m<sup>3</sup>

0.65 %

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Physical/Other properties Humidity absorption, 2mm

Water absorption, 2mm

Density





#### Injection

Drying Recommended	no	
Drying Temperature	100	°C
Drying Time, Dehumidified Dryer	3 - 4	h
Processing Moisture Content	≤0.2	%
Melt Temperature Optimum	195	°C
Min. melt temperature	180	°C
Max. melt temperature	210	°C
Screw tangential speed	≤0.3	m/s
Mold Temperature Optimum	100	°C
Min. mould temperature	80	°C
Max. mould temperature	120	°C
Hold pressure range	60 - 120	MPa
Back pressure	4	MPa
Ejection temperature	133	°C

#### Characteristics

Processing Injection Moulding

Delivery form Granules

Special characteristics Low wear / Low friction, High Flow, Low emissions

#### Additional information

Injection molding Processing

See Processing Guide and Involve Celanese FTS support to obtain best quality

parts

Processing Notes Pre-Drying

Drying is not normally required. If material has come in contact with moisture through improper storage or handling or through regrind use, drying may be

necessary to prevent splay and odor problems

Storage

The product can then be stored in standard conditions until processed.

**Automotive** 

OEM STANDARD ADDITIONAL INFORMATION

Mercedes-Benz DBL5404 BQF

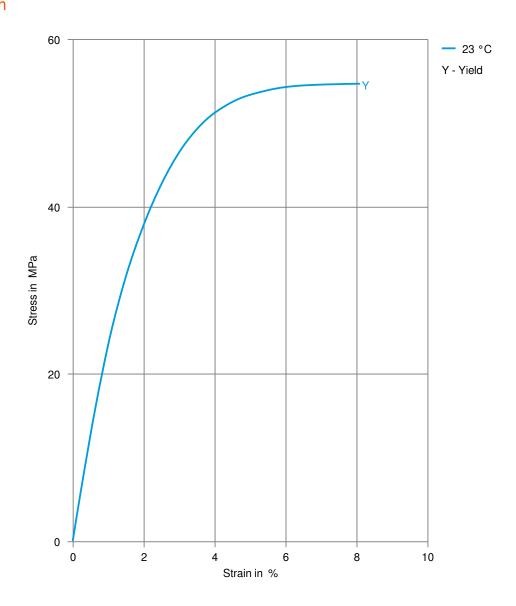
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#### Stress-strain

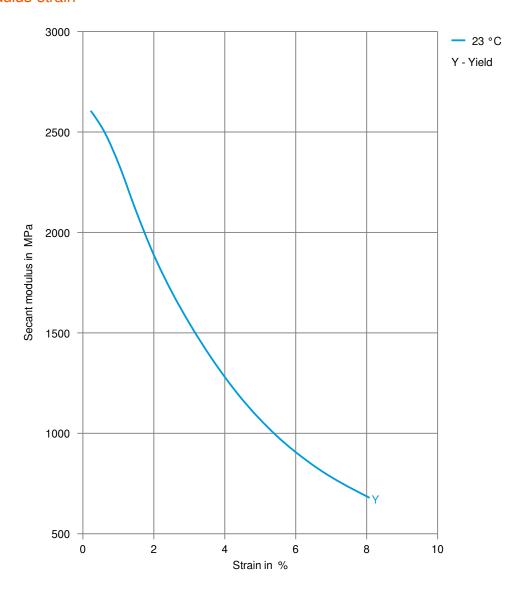


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#### Secant modulus-strain



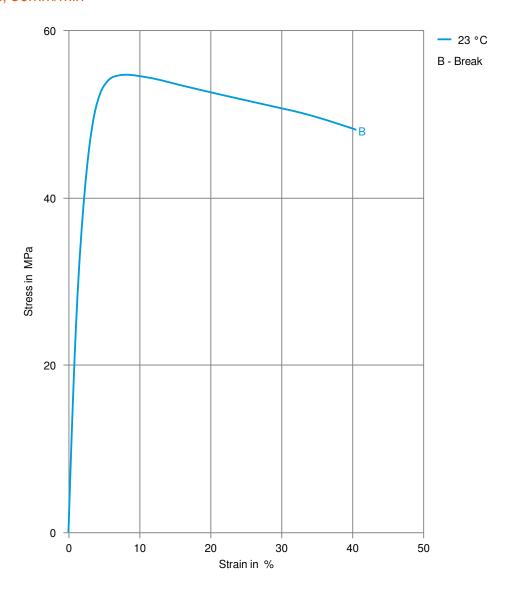
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#### Stress-strain, 50mm/min

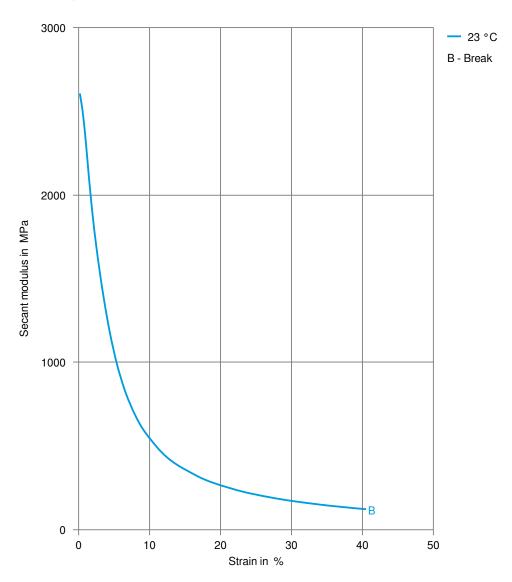


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#### Secant modulus-strain, 50mm/min

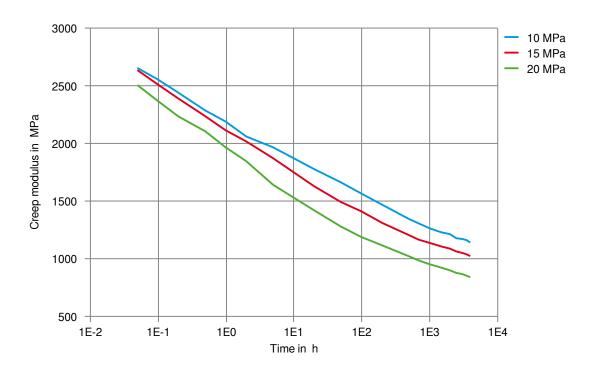


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### Creep modulus-time 23°C

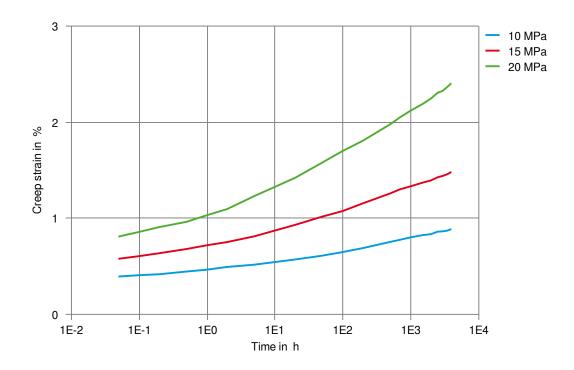


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Creep strain-time 23°C



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